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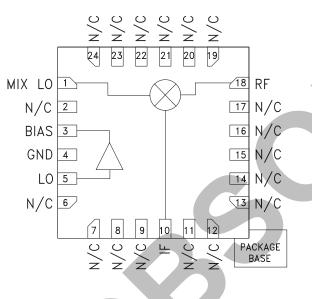


Typical Applications

The HMC551LP4 / HMC551LP4E is ideal for Wireless Infrastructure Applications:

- Cellular / 3G Infrastructure
- Base Stations & Repeaters
- GSM, CDMA & W-CDMA
- PLMR & ISM

Functional Diagram



HMC551LP4 / 551LP4E

GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 0.8 - 1.2 GHz

Features

Input IP3: +27 dBm Low Input LO Drive: -4 to +4 dBm LO to RF Isolation: 27 dB Low Conversion Loss: 8 dB Single Supply: +5V @ 62 mA 24 Lead 4x4mm QFN Package: 9 mm²

General Description

The HMC551LP4 & HMC551LP4E are high linearity, double balanced Converter ICs that operate from 0.8 to 1.2 GHz and deliver a +27 dBm input third order intercept point. The LO amplifier output and high dynamic range mixer input are positioned so that an external LO filter can be placed in series between them. The converter provides 27 dB of LO to RF isolation and is ideal for upconverter and downconverter applications. The IC operates from a single +5V supply consuming 62 mA of current and accepts a LO drive level of -4 to +4 dBm. The design requires no external baluns and supports IF frequencies between DC and 300 MHz. The HMC551LP4(E) are pin for pin compatible with the HMC552LP4(E) which operate from 1.6 to 3.0 GHz.

Electrical Specifications, $T_{A} = +25^{\circ}$ C, LO = 0 dBm, Vcc = +5V, R1 = 18 Ohms, IF = 100 MHz*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF, LO		0.8 - 1.2		GHz
Frequency Range, IF		DC - 300		MHz
Conversion Loss		8	10	dB
Noise Figure (SSB)		8		dB
LO to RF Isolation	20	27		dB
LO to IF Isolation	12	17		dB
IP3 (Input)		27		dBm
1 dB Compression (Input)		17		dBm
LO Drive Input Level (Typical)		-4 to +4	·	dBm
Supply Current (Icc)		62		mA

*Unless otherwise noted, all measurements performed as a downconverter configured as shown in application circuit.

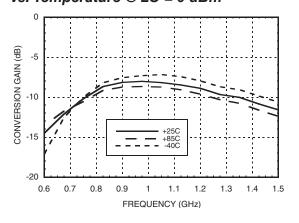
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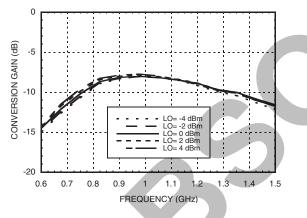


Conversion Gain vs. Temperature @ LO = 0 dBm

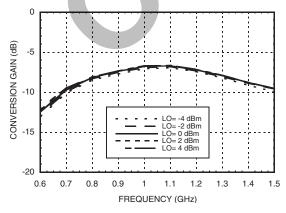


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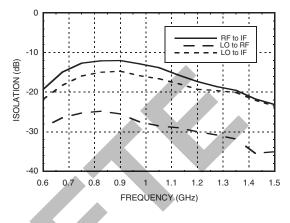
Conversion Gain vs. LO Drive



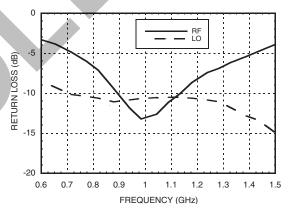
Upconverter Performance Conversion Gain vs. LO Drive



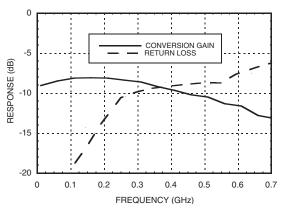
Isolation @ LO = 0 dBm



Return Loss @ LO = 0 dBm



IF Bandwidth @ LO = 0 dBm



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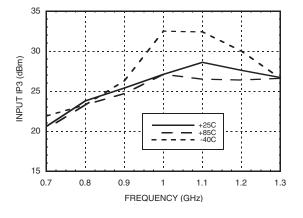
LO AMPLIFIER, 0.8 - 1.2 GHz

GaAs MMIC MIXER w/ INTEGRATED

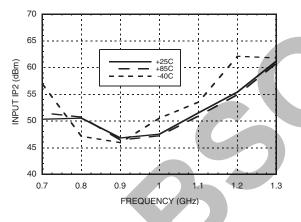
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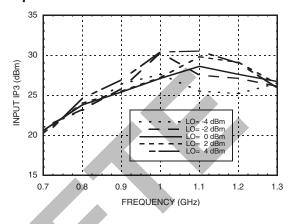
Input IP3 vs. Temperature @ LO = 0 dBm



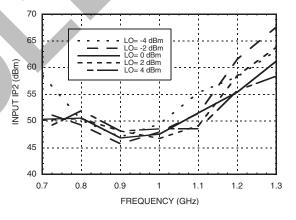
Input IP2 vs. Temperature @ LO = 0 dBm



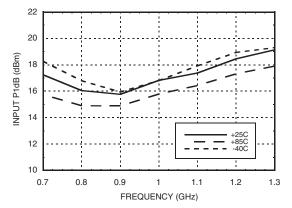
Input IP3 vs. LO Drive



Input IP2 vs. LO Drive



Input P1dB vs. Temperature @ LO = 0 dBm



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LO AMPLIFIER, 0.8 - 1.2 GHz

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MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	xx	-3	33	21	21
1	4	0	13	35	45
2	81	68	63	60	74
3	87	102	85	74	71
4	106	96	102	103	103
RF Freq. = 0.9 GHz @ -10 dBm LO Freq. = 0.8 GHz @ 0 dBm All values in dBc relative to the IF power level.					

Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
0.7	24	21	34	40
0.8	25	22	34	49
0.9	27	23	38	57
1.0	28	23	43	45
1.1	29	24	43	54
1.2	30	25	37	61
LO = 0 dBm All values in dBc below input LO level measured at BE port				

Typical Supply Current

Vcc	lcc (mA)
+5.0	62 mA

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LO AMPLIFIER, 0.8 - 1.2 GHz

Absolute Maximum Ratings

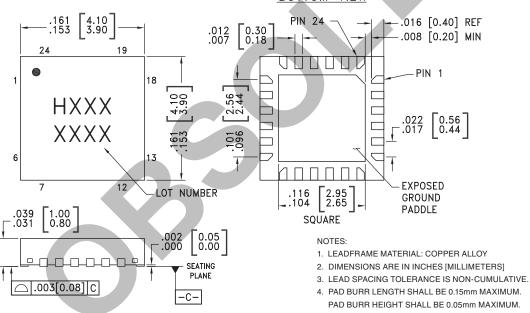
RF / IF Input (Vcc= +5V)	+31 dBm
LO Drive (Vcc= +5V)	+10 dBm
BIAS	+7 Vdc
Junction Temperature	150°C
Continuous Pdiss (T = 85°C) (derate 9.5 mW/°C above 85°C)	0.6 W
Thermal Resistance (junction to ground paddle)	105.6 °C/W
Storage Temperature	-65 to +150°C
Operating Temperature	-40 to +85°C
ESD Sensitivity (HBM)	Class 1C

Outline Drawing



GaAs MMIC MIXER w/ INTEGRATED





- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC551LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H551 XXXX
HMC551LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H551</u> XXXX

[1] Max peak reflow temperature of 235 $^\circ\text{C}$

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	MIX LO	This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.	MIX LOO
2, 6 - 9, 11 - 17, 19 - 24	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
3	BIAS	Power supply for the LO amplifier Bias resistor is required . Three external bypass capacitors are recom- mended for optimum performance, as illustrated in the application circuit.	BIASO
4	GND	Backside of package has exposed metal ground paddle that must also be connected to ground.	
5	LO	This pin is DC coupled and matched to 50 Ohms from 0.8 to 1.2 GHz. An off chip DC blocking capacitor is required.	LOO
10	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/ sink more than 18 mA of current or die non-function and possible die failure will result.	
18	RF	This pin is DC coupled and matched to 50 Ohms.	RF O



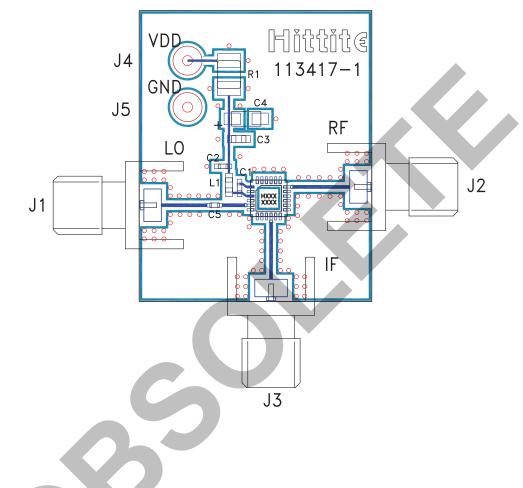
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Evaluation PCB



List of Materials for Evaluation PCB 113419^[1]

Item	Description	
J1 - J3	PCB Mount SMA RF Connector	
J4, J5	DC Pin	
C1, C2, C5	100 pF Chip Capacitor, 0402 Pkg.	
C3	1000 pF Chip Capacitor, 0603 Pkg.	
C4	2.2 µF Capacitor, Tantalum	
L1	56 nH Chip Inductor, 0603 Pkg.	
R1	18 Ohm Resistor, 1210 1/8 watt Pkg.	
U1	HMC551LP4 / HMC551LP4E	
PCB [2]	113417 Evaluation Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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Application Circuit

